

5. Usual and Unusual Behaviours

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Typical nanoindentation data

Alumina

$E = 400 \text{ GPa}$
 $H = 22 \text{ GPa}$

$E/H = 18$
 $U_e/U_p = 120\%$

Silicon

$E = 180 \text{ GPa}$
 $H = 10 \text{ GPa}$

$E/H = 18$
 $U_e/U_p = 118\%$

Glass

$E = 72.6 \text{ GPa}$
 $H = 5.4 \text{ GPa}$

$E/H = 13.4$
 $U_e/U_p = 102\%$

Nickel

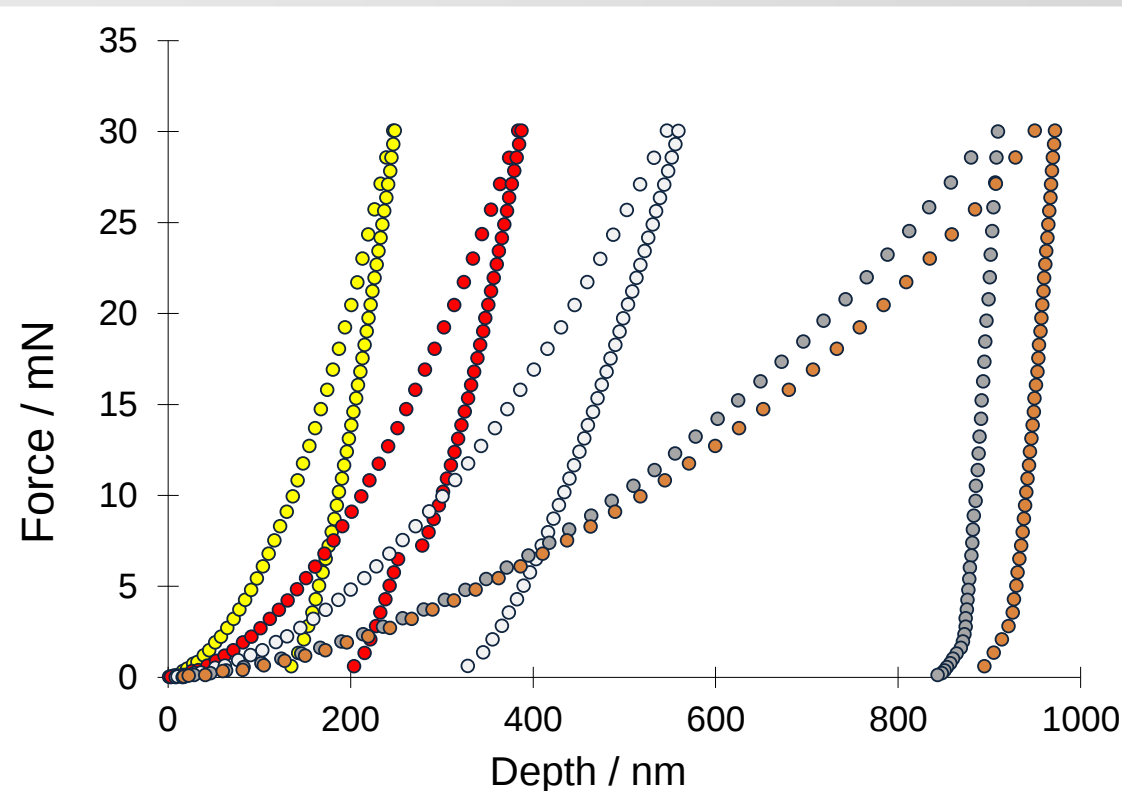
$E = 210 \text{ GPa}$
 $H = 1.4 \text{ GPa}$

$E/H = 150$
 $U_e/U_p = 6.02\%$

Copper

$E = 120 \text{ GPa}$
 $H = 1.2 \text{ GPa}$

$E/H = 100$
 $U_e/U_p = 8.34\%$



Hardness

$$H = \frac{F}{A}$$

Elastic modulus

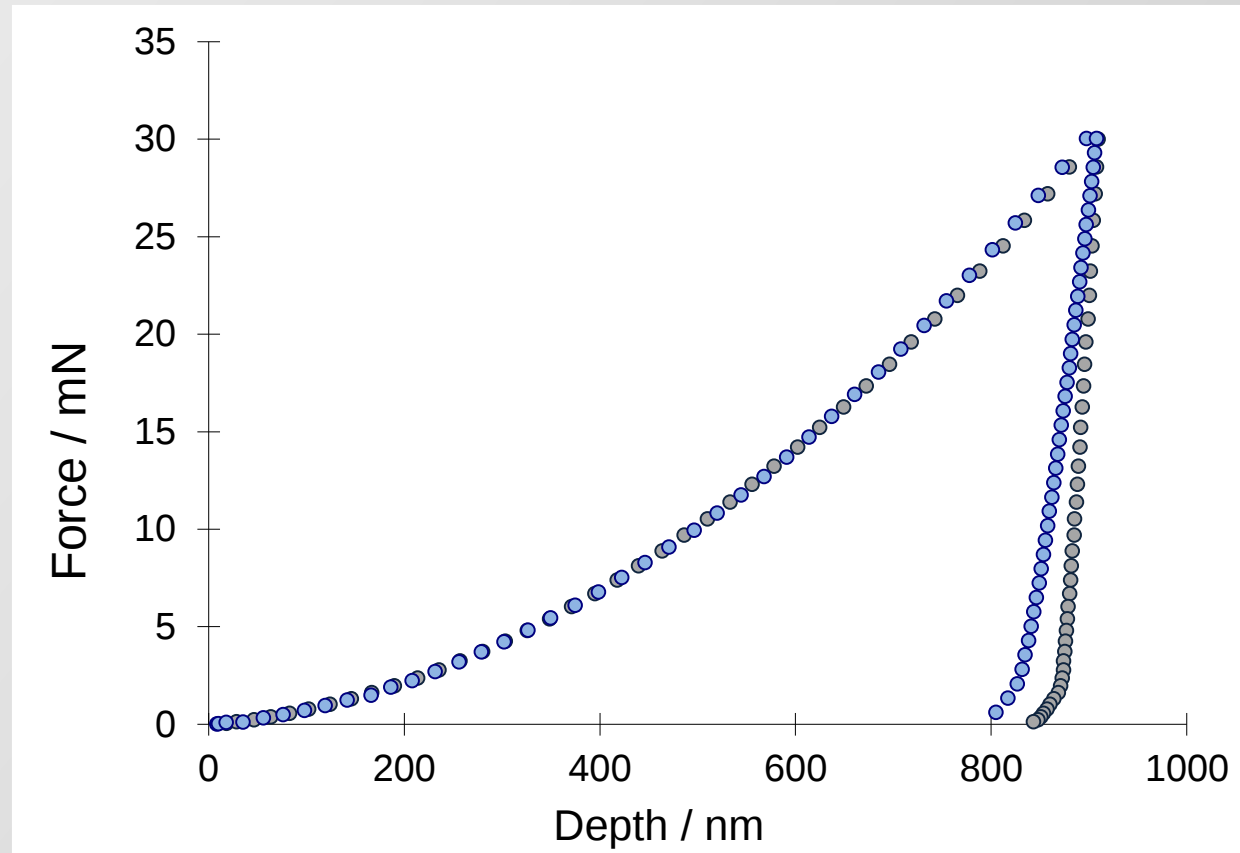
$$E^* = \beta \frac{\sqrt{\pi}}{2} \frac{\left(\frac{dF}{dh} \right)}{\sqrt{A}}$$

Typical nanoindentation data

Same hardness
Different modulus

Nickel
 $E = 210 \text{ GPa}$
 $H = 1.4 \text{ GPa}$

Aluminium
 $E = 70 \text{ GPa}$
 $H = 1.4 \text{ GPa}$



Typical nanoindentation data

Same modulus
Different hardness

Glass

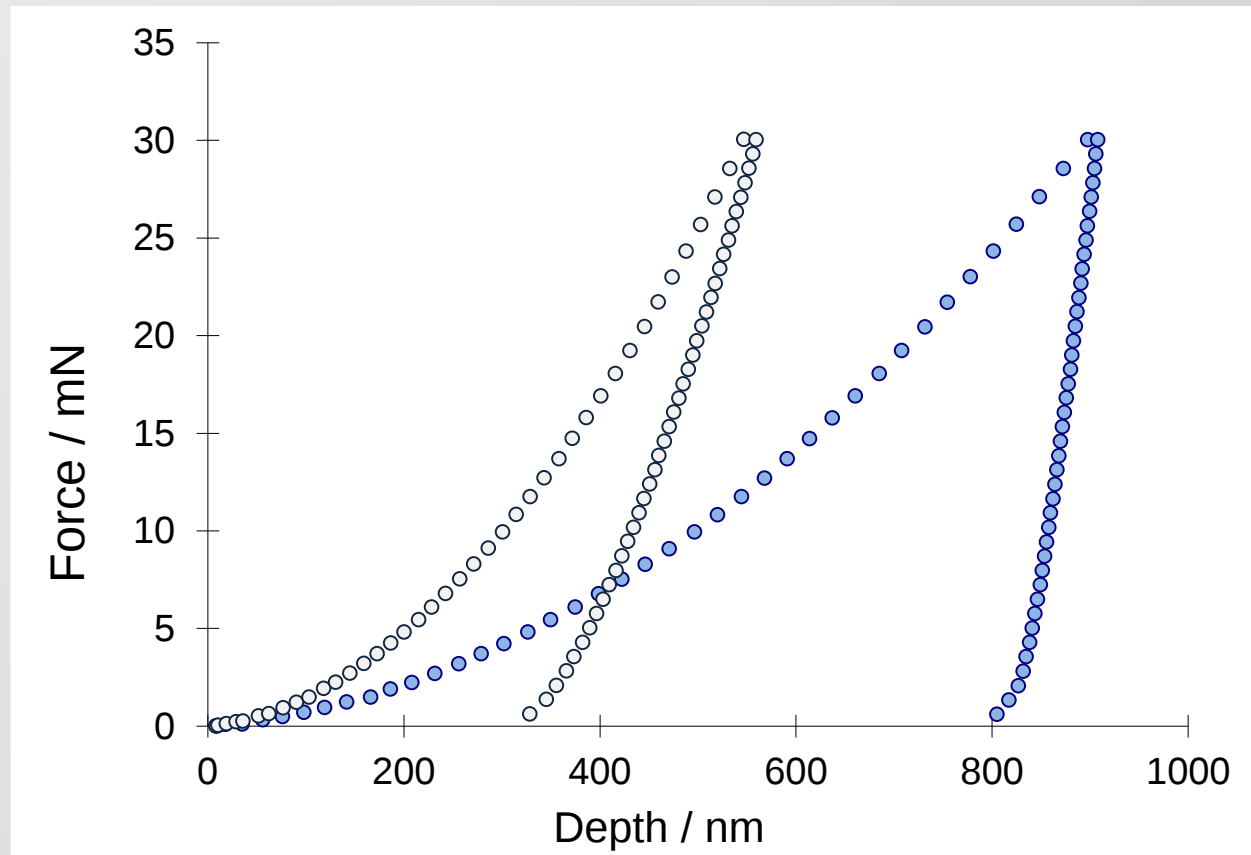
$E = 72.6 \text{ GPa}$

$H = 5.4 \text{ GPa}$

Aluminium

$E = 70 \text{ GPa}$

$H = 1.4 \text{ GPa}$

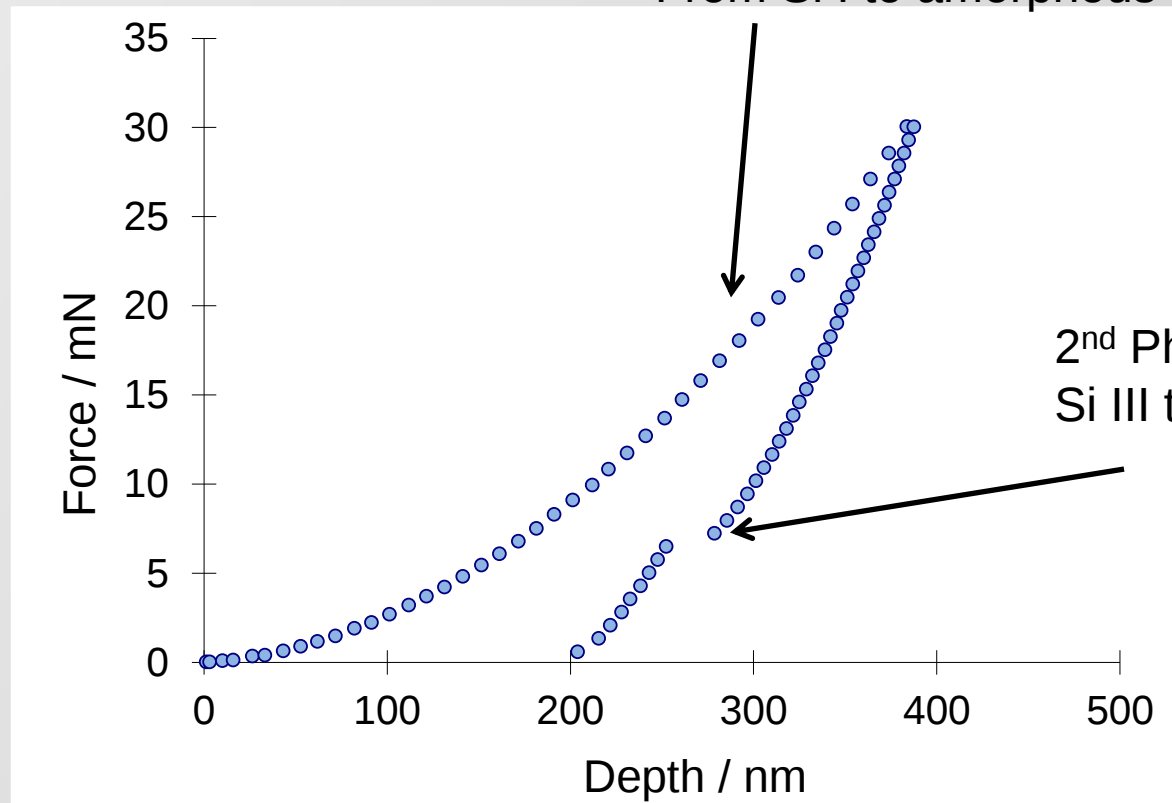


Silicon

$E = 180 \text{ GPa}$

$H = 10 \text{ GPa}$

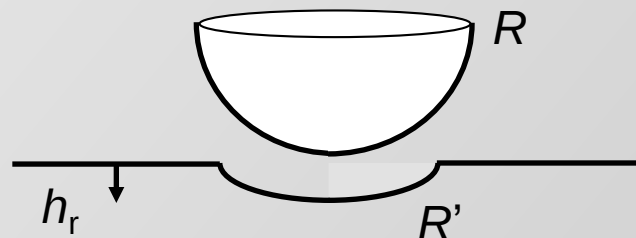
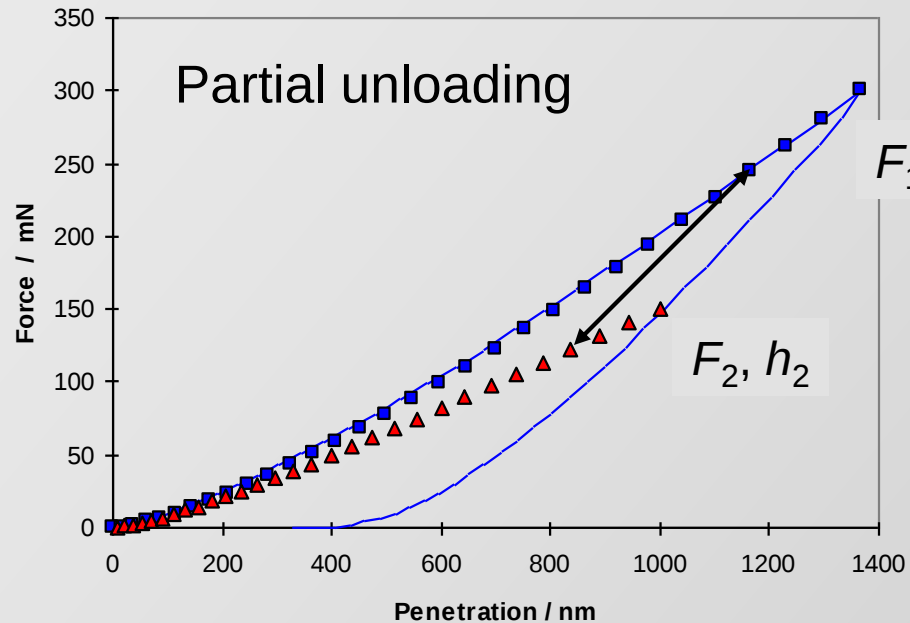
Pressure induced phase transformation
From Si I to amorphous Si at ~12GPa



2nd Phase transformation from
Si III to Si XII on unloading
(crystallisation)

Multi-cycle tests: load – partial unload

Determine contact radius, a , as a function of depth (spherical indenters)



$$h_c = \frac{h_{\max} + h_r}{2}$$

$$h_e = 2(h_{\max} - h_c)$$

$$a^2 = (2Rh_c - h_c^2)$$

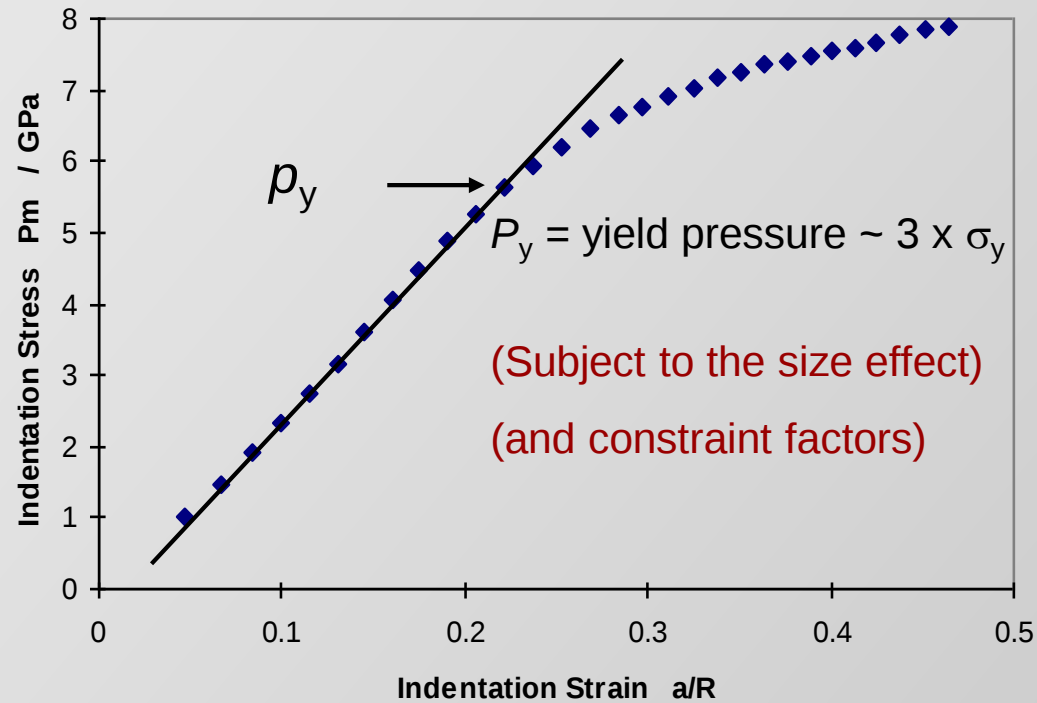
$$h_e = \left(\frac{9}{16} \frac{F^2}{E^{*2}} \frac{1}{R^*} \right)^{1/3}$$

$$E^* = \left(\frac{3}{4} \frac{F}{h_e^{3/2}} \frac{1}{R^{*1/2}} \right)$$

Indentation stress-strain curves

$$\text{Indentation stress} = P_m = F / \pi a^2$$

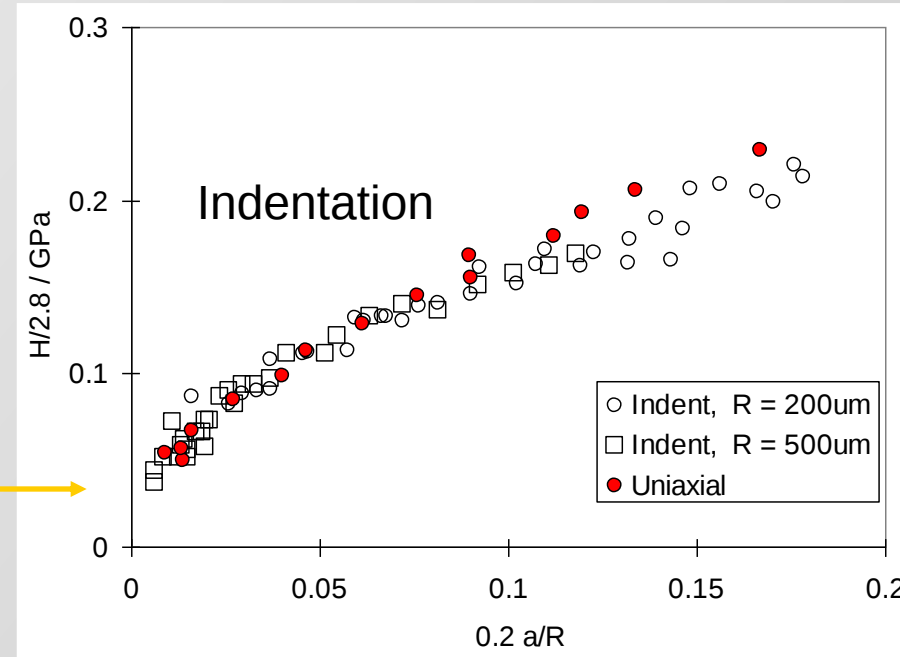
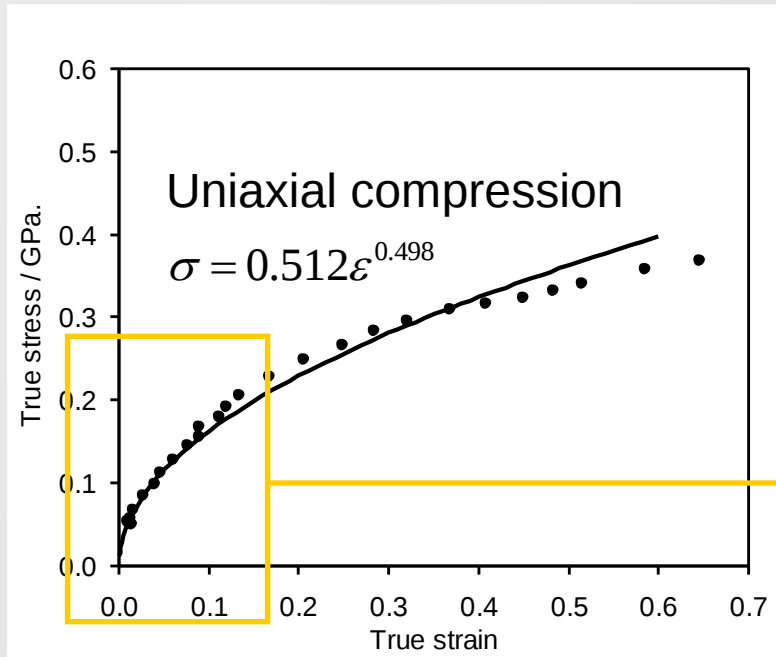
$$\text{Indentation strain} = a / R$$



Meyer's Law
$$P_m = k \left(\frac{a}{R} \right)^m$$
 $m = \text{hardening rate}$

Indentation stress-strain curves

Example for annealed copper



The Tabor relations

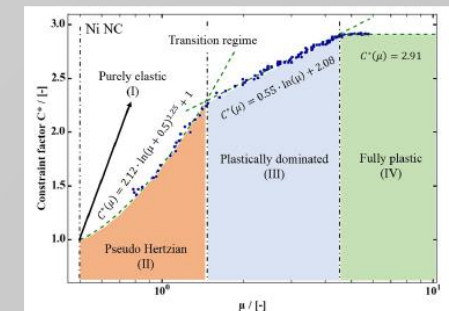
$$\left\{ \begin{array}{l} \text{Representative stress} = P_m / 2.8 \\ \text{Representative strain} = 0.2 a/R \end{array} \right.$$

Constraint factor, $C^*(\mu)$

$$\mu = \frac{E_r \cot \theta}{H \pi}$$

Tabor – The Hardness of Metals, 1951

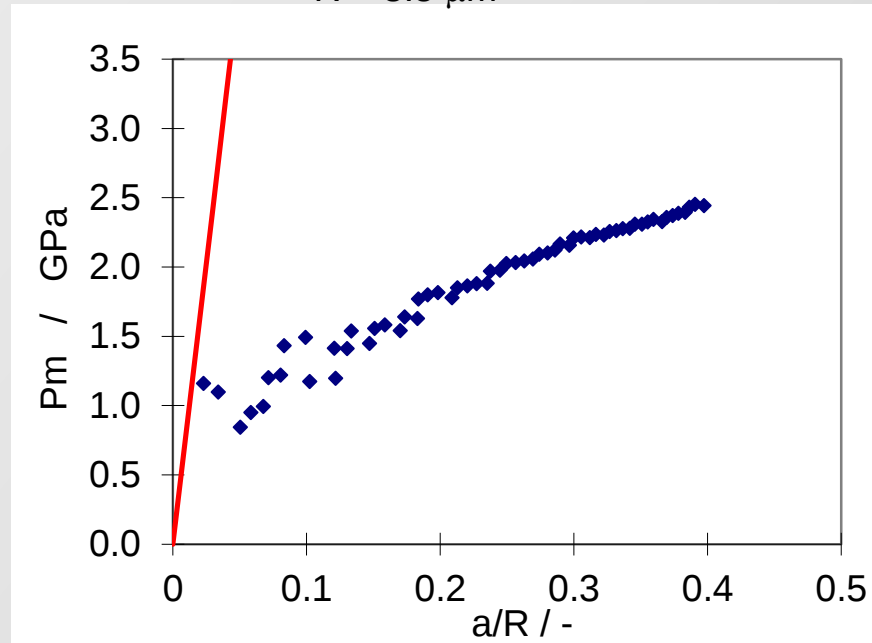
Spary, Bushby and Jennett, Phil. Mag., **A86**, 5581 (2006)



Leitner et al. / Materials and Design **146** 69 (2018)

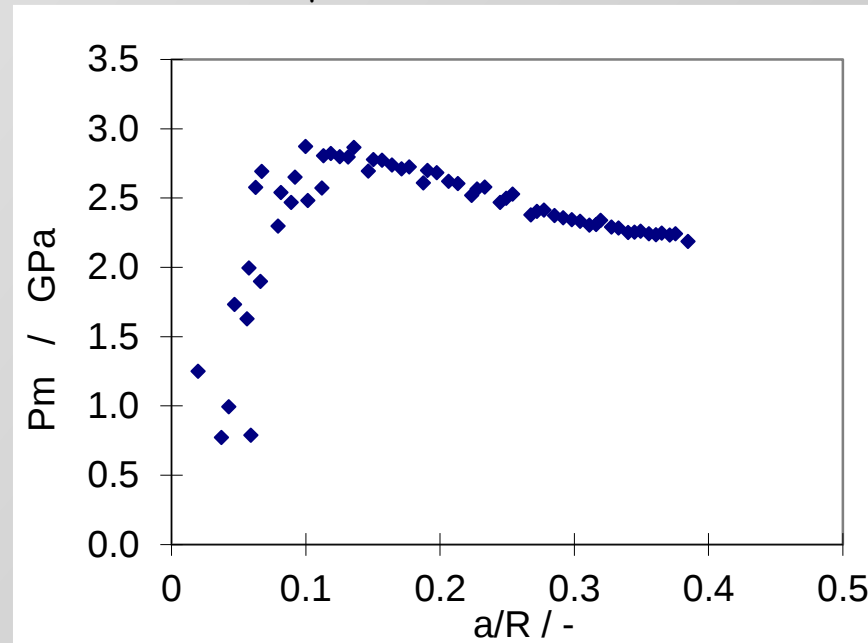
Strain hardening

Example for annealed Ni
 $R = 3.5 \mu\text{m}$

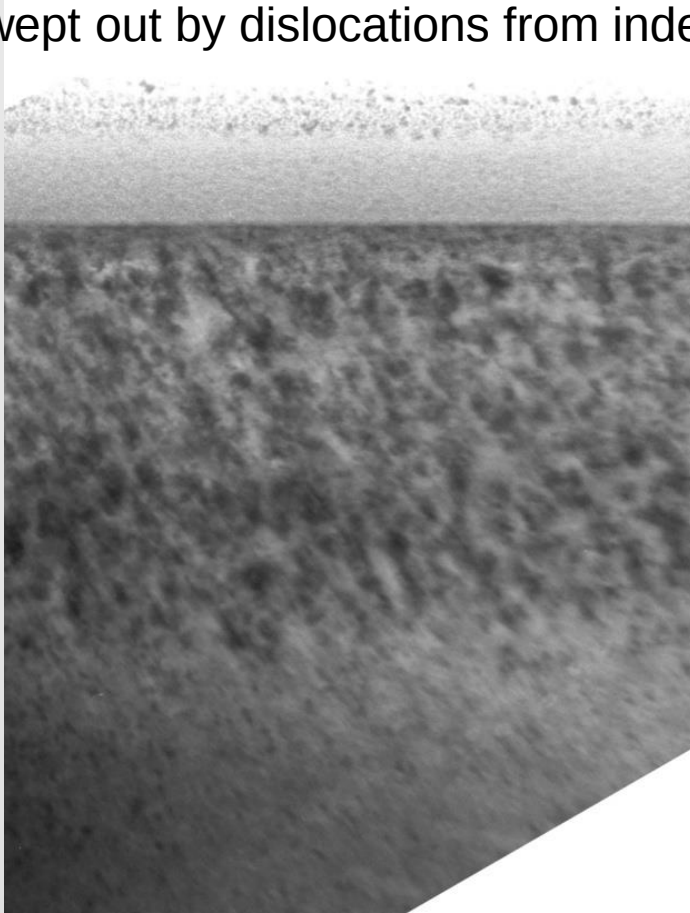


Strain softening

Example for irradiated Fe 12% Cr
 $R = 3.5 \mu\text{m}$

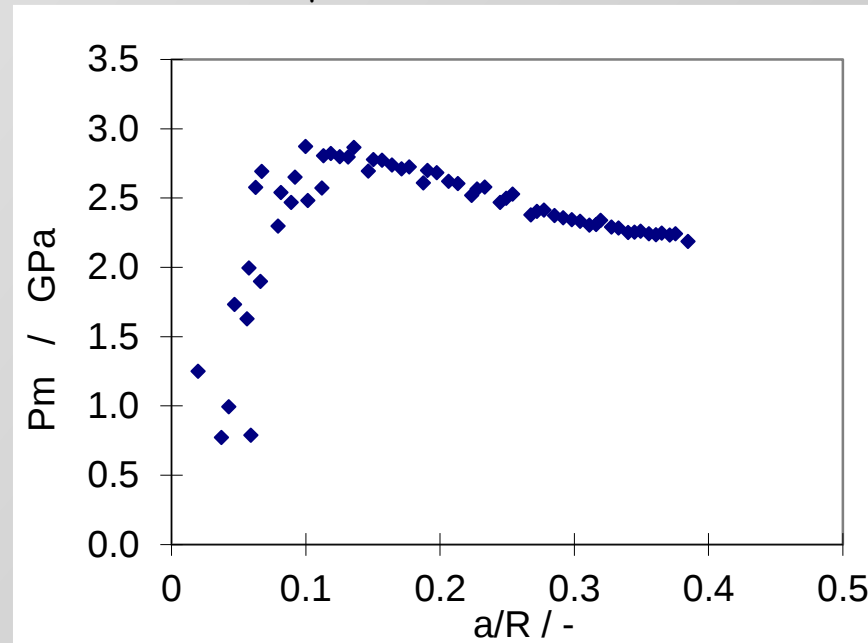


Irradiation damage
Dislocation loops and Frenkel defects
Swept out by dislocations from indentation



Strain softening

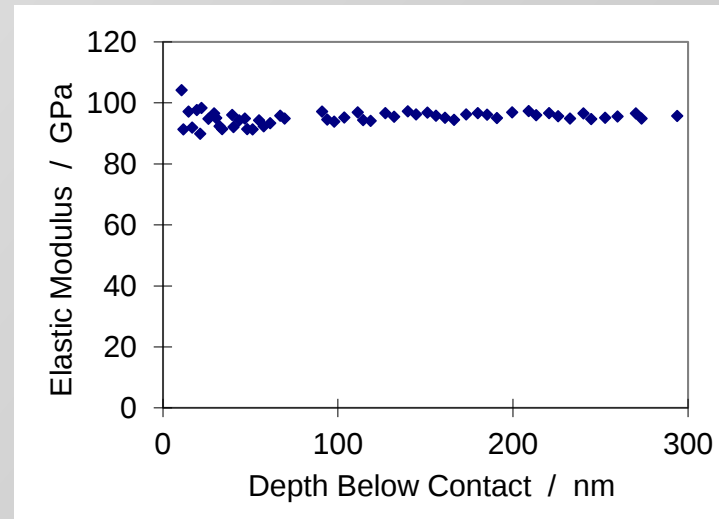
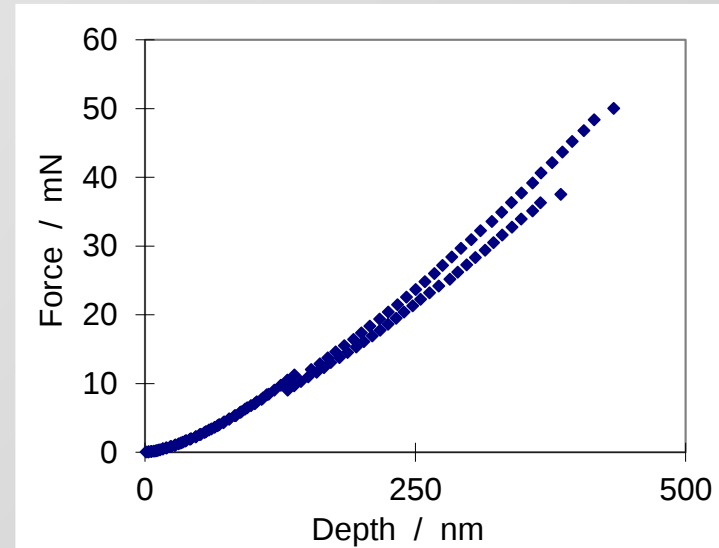
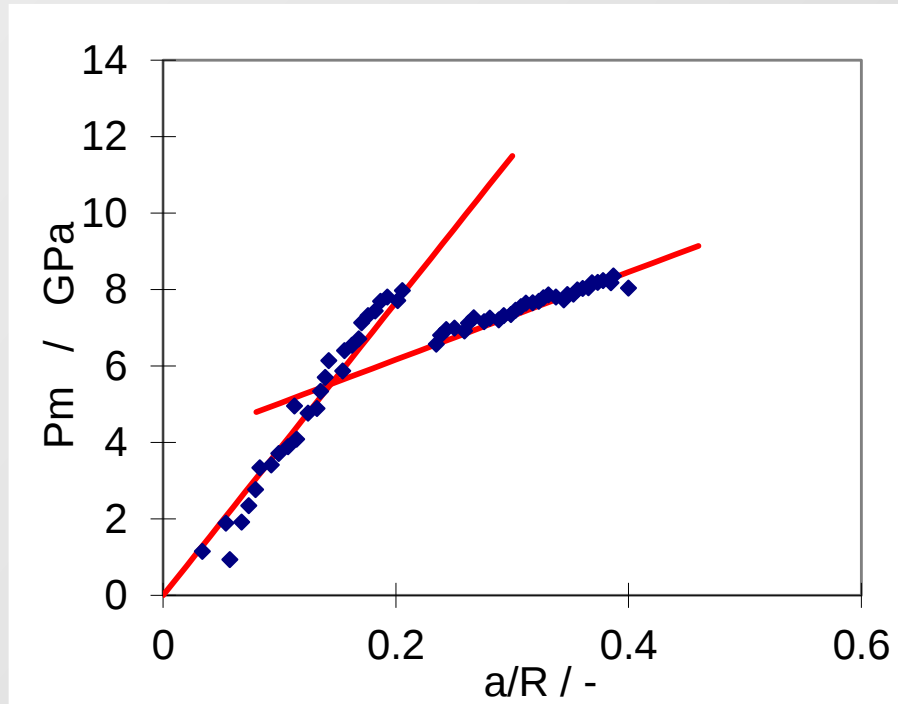
Example for irradiated Fe 12% Cr
 $R = 3.5 \mu\text{m}$



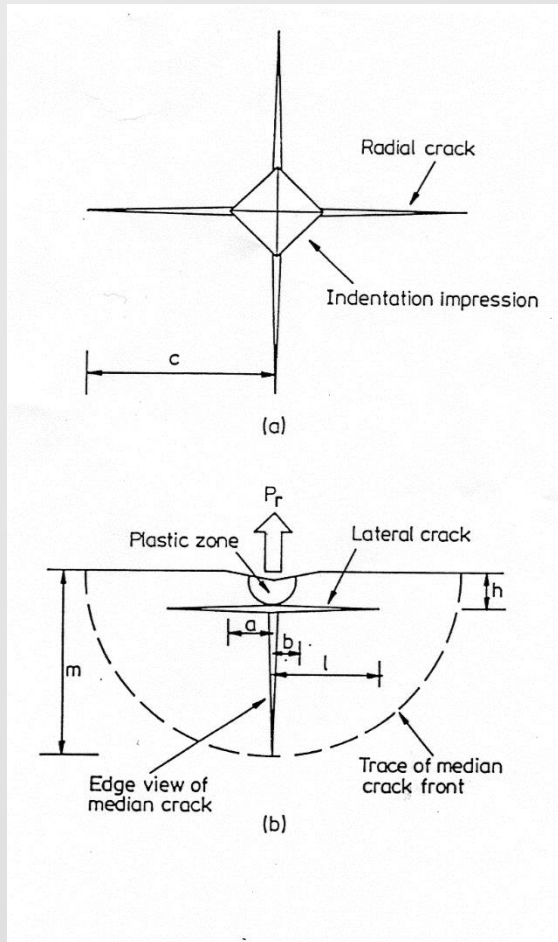
Pop-in: sudden transition to plasticity

Nucleation of dislocation source
- no change in sample stiffness

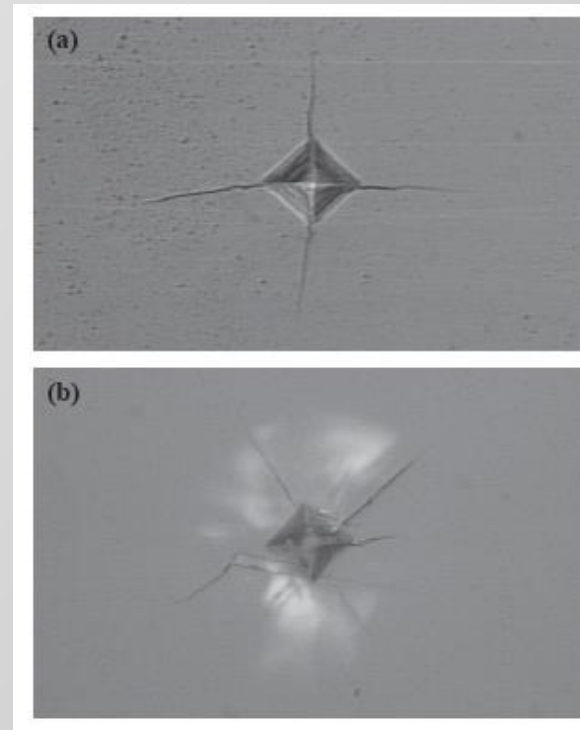
Example for annealed InGaAs
 $R = 3.5 \mu\text{m}$



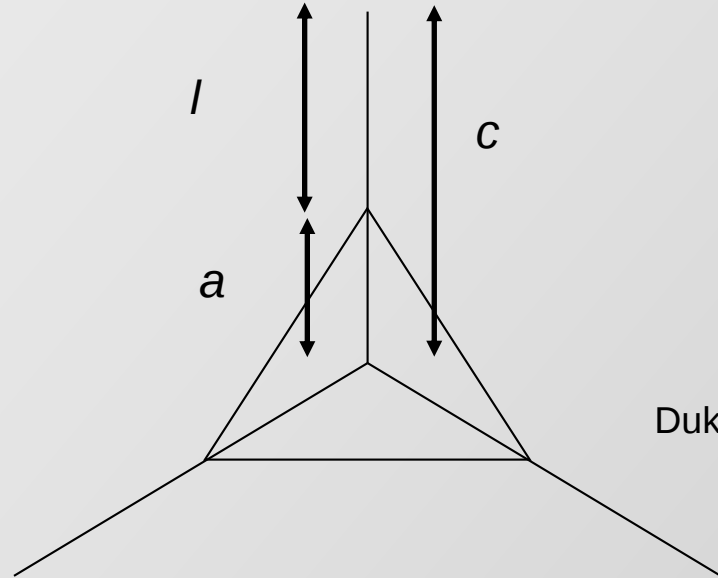
Cracking beneath sharp indenters:



Two systems of cracks
Radial (on loading)
Lateral (on unloading)



K_{IC} from indentation crack length measurements:



$$K_c = 0.0161 \left(\frac{a}{l} \right)^{1/2} \left(\frac{E}{H} \right)^{2/3} \frac{F}{c^{3/2}}$$

Dukino and Swain, J. Amer. Ceram. Soc. 75, 3299 (1992)

Requires sharp indenter (Berkovich or Corner cube)

Make a series of measurements at different forces

SEM to measure crack lengths

Plot F vs $c^{3/2}$, find K_{IC} from slope

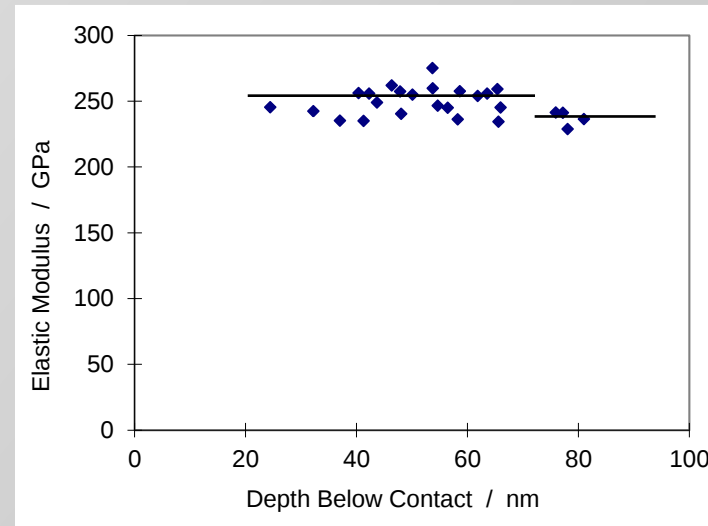
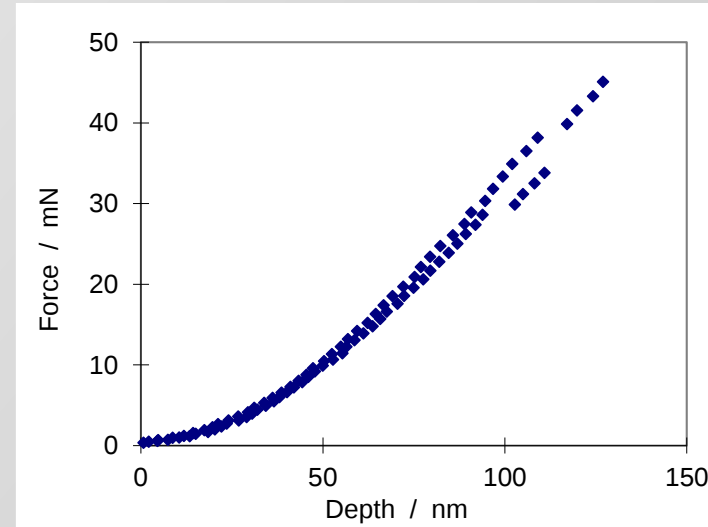
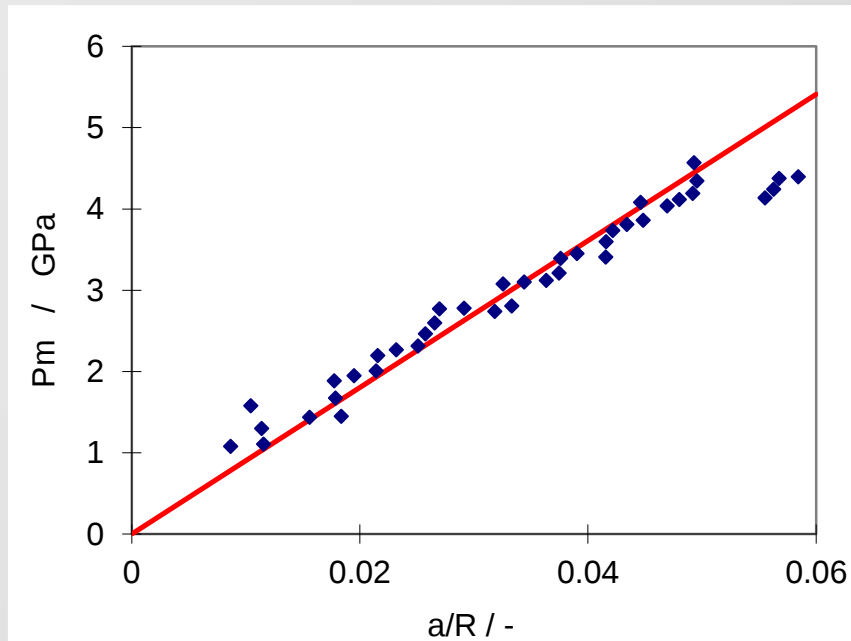
Only works on very brittle materials (ceramics), $K_{IC} < 10 \text{ MPa}\sqrt{\text{m}}$

Toughness measurements from very small amount of material

Cracking: sudden increase in depth

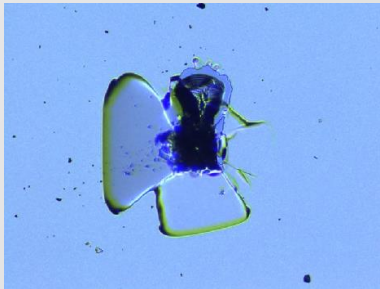
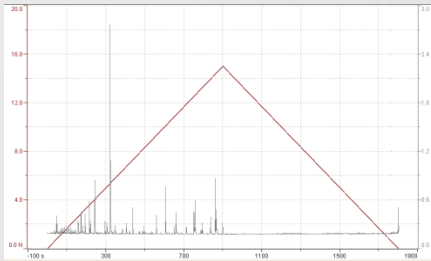
Nucleation of cracks
- drop in sample stiffness

Example for NbN / TiN multilayer
 $R = 20 \mu\text{m}$

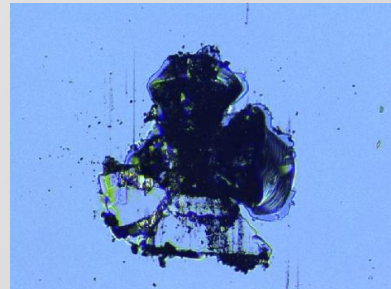
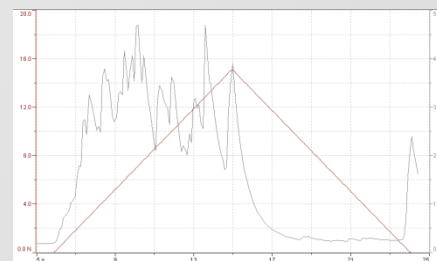


Microindentation with Acoustic Emission (AE)

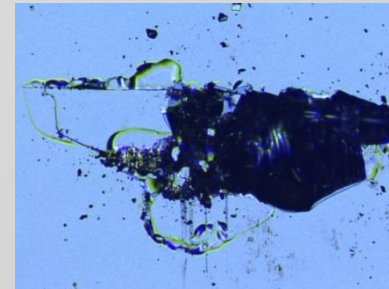
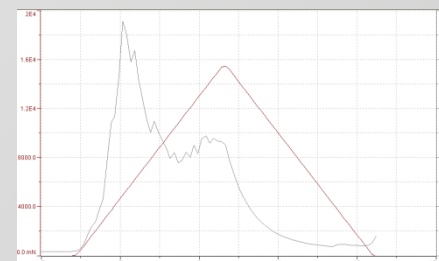
1 N/m



100 N/m



250 N/m



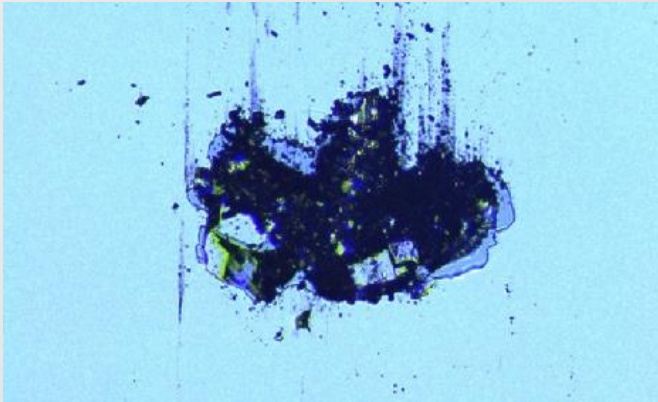
Sample: Glass

Indenter: Vickers

Max load: 15 N

Instrument: MCT

Microindentation with Acoustic Emission (AE)



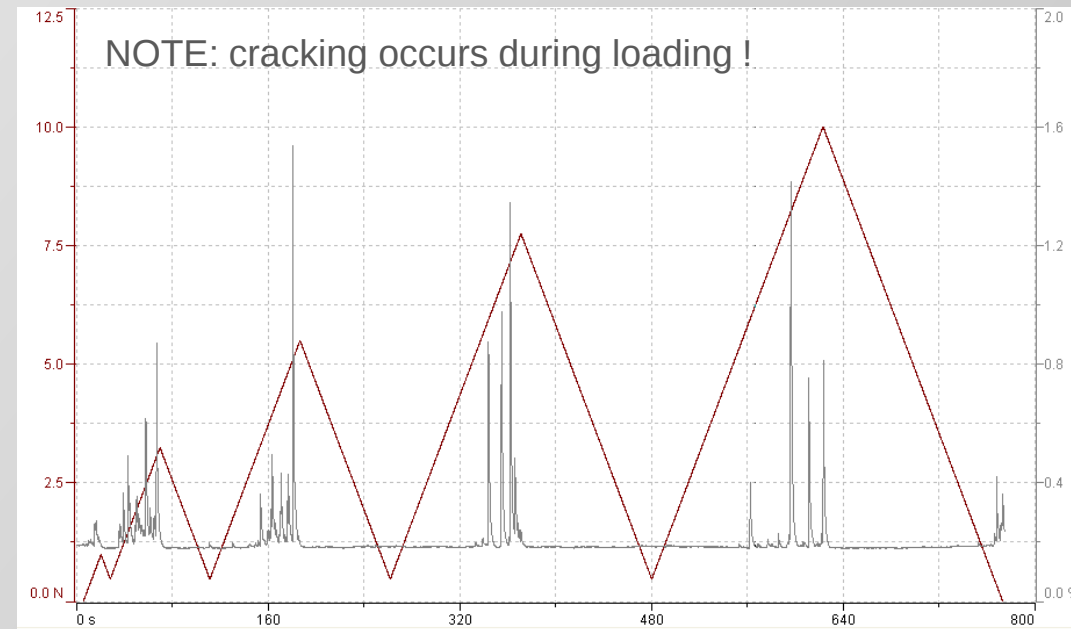
Sample: Si wafer

Indenter: Vickers

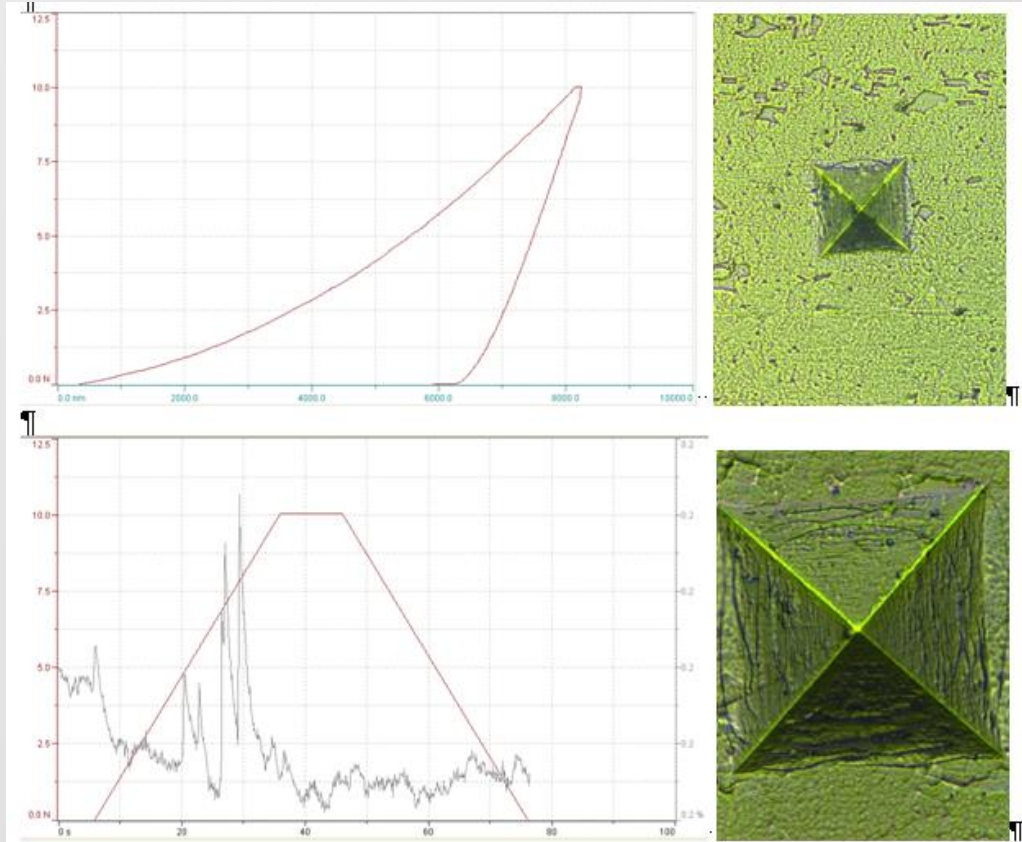
Load: 1 - 10 N

Progressive multicycle
(4 cycles)

Instrument: MCT



Microindentation with Acoustic Emission (AE)



Sample: TiN-on-steel

Indenter: Vickers

Max load: 10 N

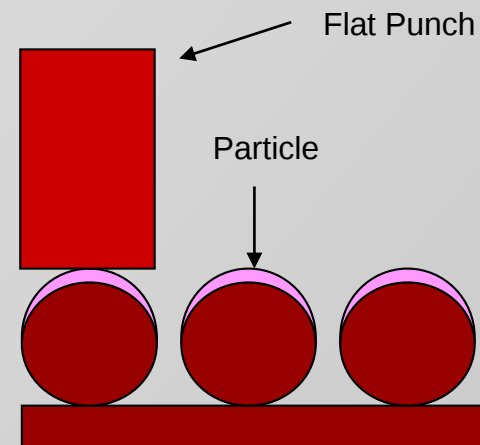
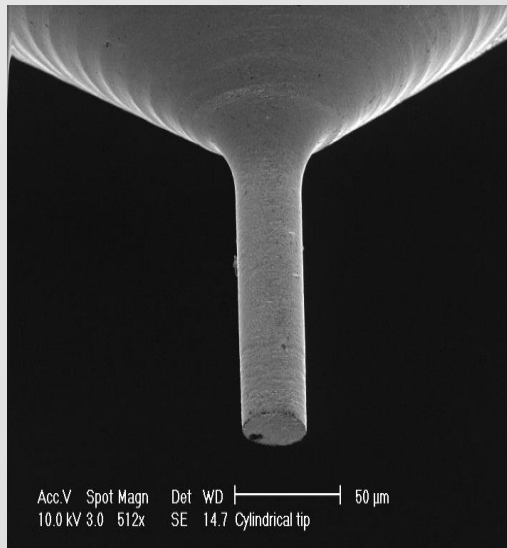
Loading rate: 20 N/min.

Pause at mx load: 10s

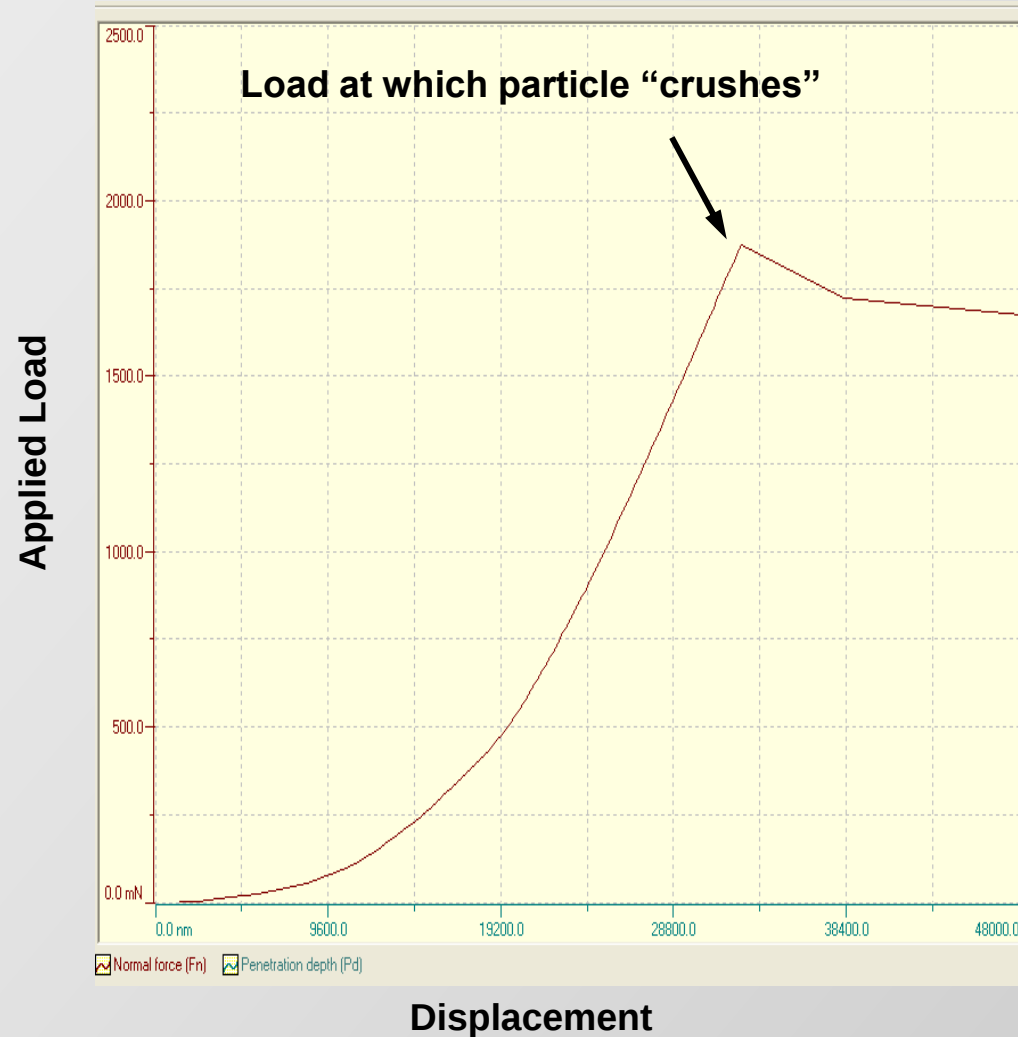
Instrument: MCT

Crush testing of powder particles

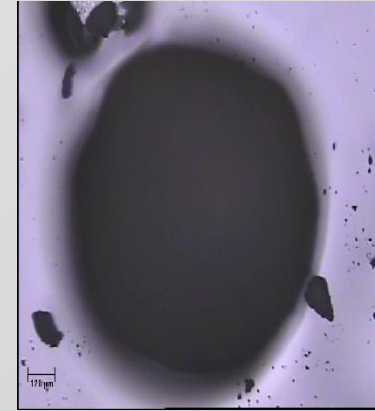
- Particles are scattered randomly across glass slide
- Flat punch (e.g. diameter 1.5 mm) used to crush
- Optical microscope used to predefine particle position
- Many particles can be tested with full automation
- Maximum load required to crush particle is recorded



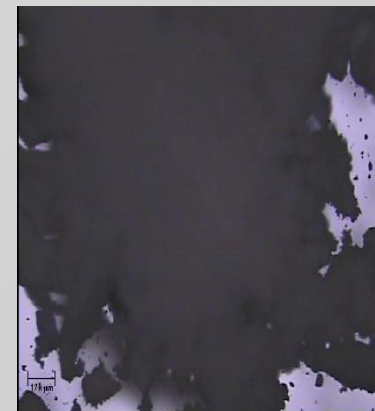
Crush testing of powder particles



Before



After



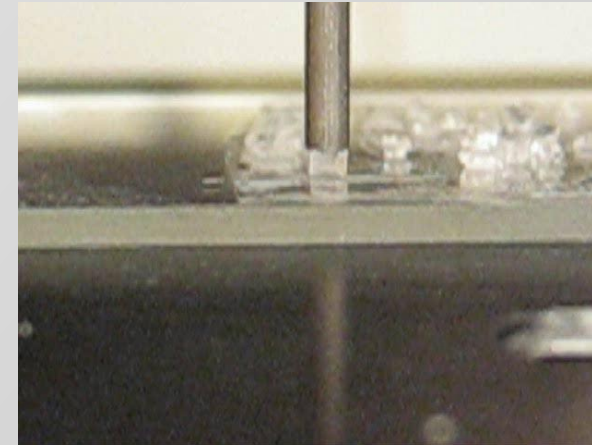
Crush testing of powder particles (movie)



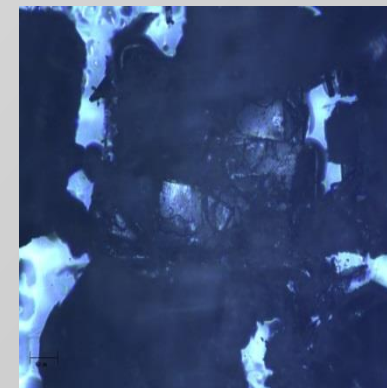
Microindentation of sucrose particles



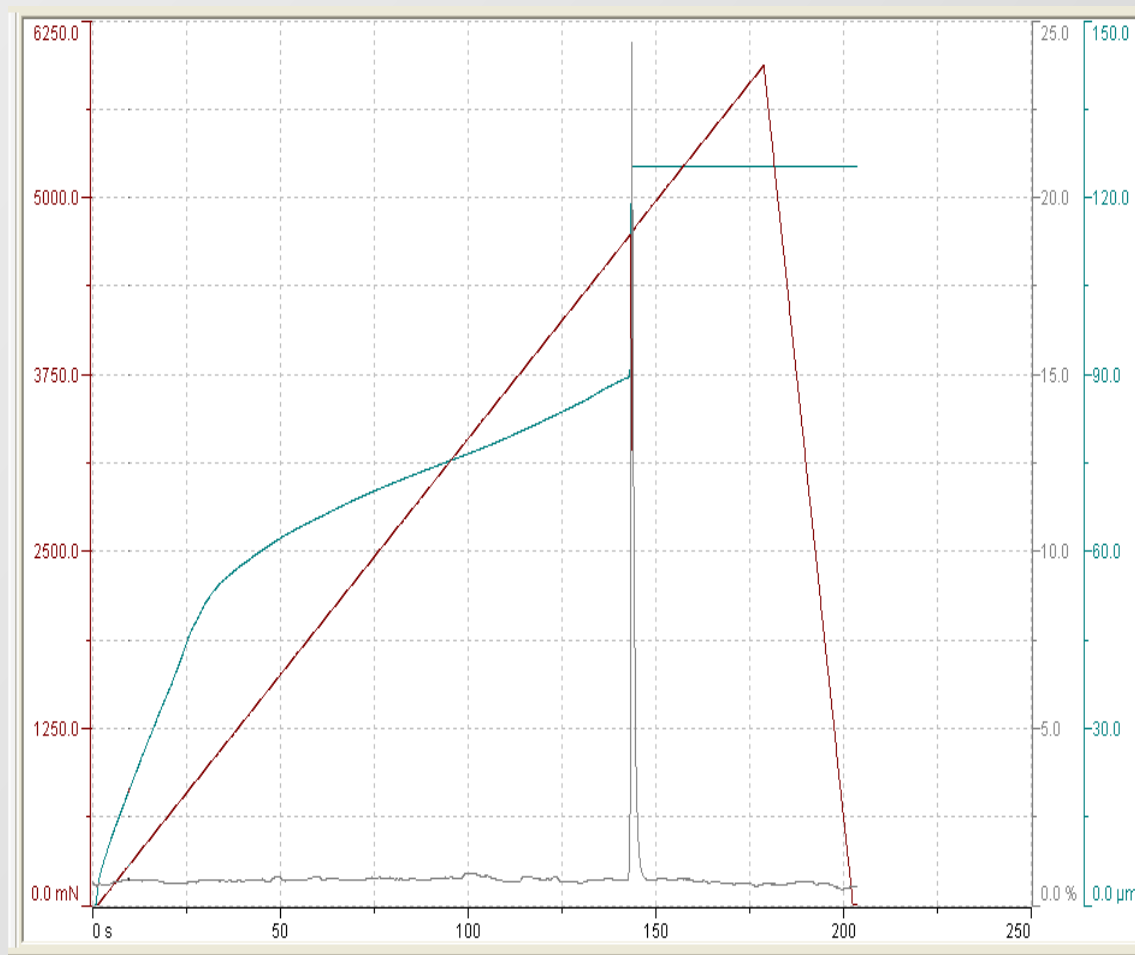
Before



After



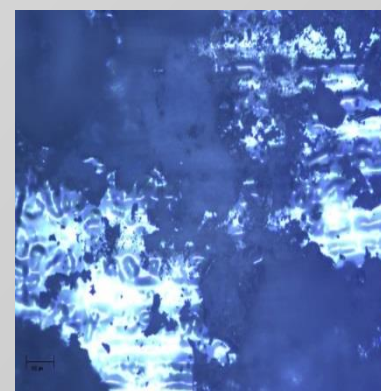
Microindentation of citric acid particles



Before



After



- **Response of material related to E/H**
- **Elastic recovery vs plasticity, work of indentation**
- **Spherical indenters for indentation stress-strain behaviour**
- **Plastic deformation - strain hardening or softening, pop-in events**
- **Fracture toughness and fracture events (acoustic emissions)**
- **Mechanical testing – compression testing**